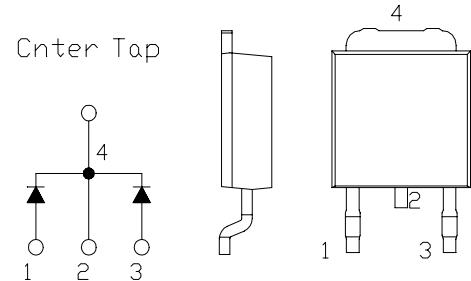


FRD Type : EA61FC4-F

OUTLINE DRAWING

FEATURES

- * TO-252AA Case, Surface Mounting Device
- * Packaged in 16mm Tape and Reel
- * Ultra - Fast Recovery
- * Low Forward Voltage drop
- * Low Power Loss
- * High Surge Capability
- * 200 Volts thru 600 Volts Types Available



Maximum Ratings

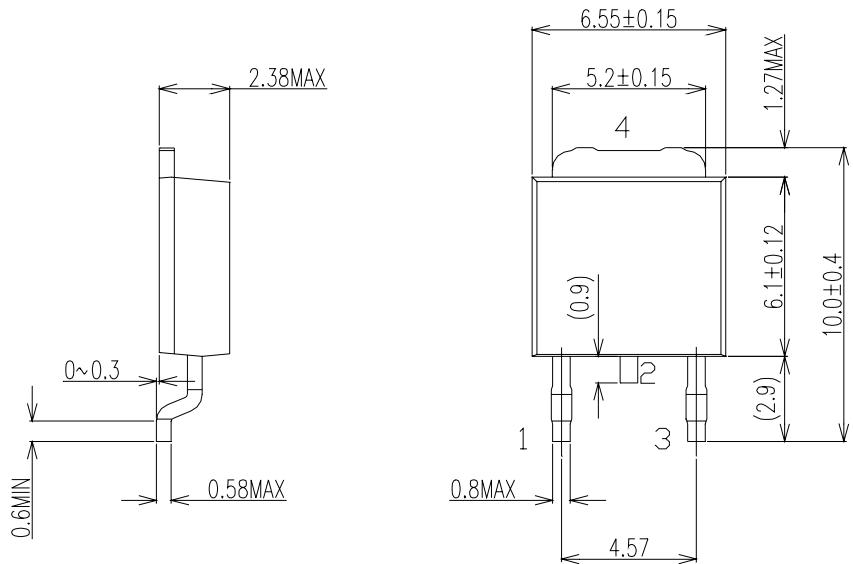
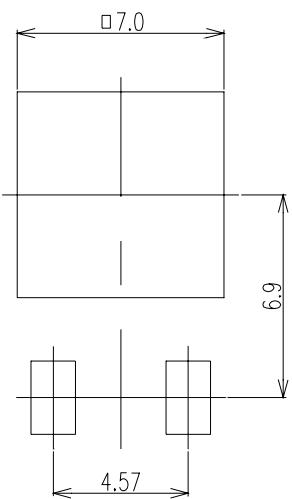
Approx Net Weight:0.30g

Rating	Symbol	EA61FC4-F				Unit
Repetitive Peak Reverse Voltage	V _{RRM}	400				V
Non-repetitiv Peak Reverse Voltage	V _{RSM}	440				
Average Rectified Output Current	P.C. Board mounted *	Io	1.7	T _a =26°C	50Hz Full Sine Wave Resistive Load	
			6.0	T _c =109°C		
RMS Forward Current	I _{F(RMS)}	6.66				A
Surge Forward Current	I _{FSM}	45	50Hz Full Sine Wave, 1cycle, Non-repetitive			
Operating JunctionTemperature Range	T _{jw}	- 40 to + 150				°C
Storage Temperature Range	T _{stg}	- 40 to + 150				°C

Electrical • Thermal Characteristics

Characteristics		Symbol	Conditions	Min	Typ	Max	Unit
Peak Reverse Current	I _{RM}	T _j =25°C, V _{RM} =V _{RRM} per Arm	-	-	20		µA
Peak Forward Voltage	V _{FM}	T _j =25°C, I _{FM} = 3 A per Arm	-	-	1.25		V
Reverse Recovery Time	trr	I _{FM} = 3 A, -di/dt= 50 A/µs, T _a = 25°C	-	-	30		ns
Thermal Resistance	Junction to Ambient	R _{th(j-a)}	P.C. Board mounted *	-	-	80	°C/W
	Junction to Case	R _{th(j-c)}	-	-	-	5	°C/W

* Print Land = 20x20 mm

EA61FC4-F OUTLINE DRAWING (Dimensions in mm)

SOLDERING PAD


Center Tap

